

## Description

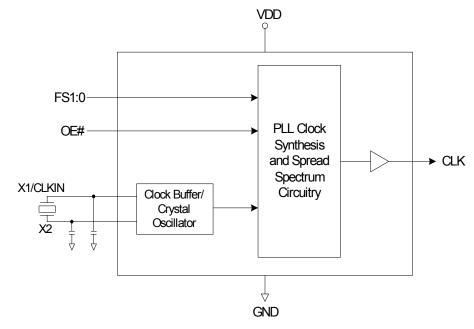
The ICS4231-03 generates a low EMI output clock from a clock or crystal input. The device uses ICS' proprietary mix of analog and digital Phase Locked Loop (PLL) technology to spread the frequency spectrum of the output, thereby reducing the frequency amplitude peaks by several dB.

The ICS4231-03 offers four different center and down spread selections. Refer to the MK1714-01/02 for the widest selection of input frequencies and multipliers.

ICS offers a complete line of EMI reducing clock generators. Consult us when you need to remove crystals and oscillators from your board.

#### Features

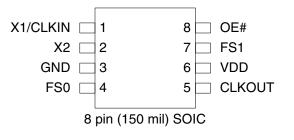
- Pin and function compatible to Cypress W42C31-03
- Packaged in 8-pin SOIC (Pb free available)
- Provides a spread spectrum output clock
- Accepts a clock or crystal input and provides same frequency dithered output
- Input clock frequency of 10 to 33 MHz
- Peak reduction by 8dB 14dB typical on 3rd 19th odd harmonics
- Spread percentage selections of ±1.875%, ±1.0%, and -2.0%
- Operating voltage of 5V
- Advanced, low-power CMOS process



### **Block Diagram**



### **Pin Assignment**



# **Output Enable Function Table**

| OE#<br>(Pin 8) | Output Status |
|----------------|---------------|
| 0              | Running       |
| 1              | Tri-state     |

0 = connect to GND 1 = connect directly to VDD Note: OE# pin has an internal pull-down resistor

### **Frequency Range and Spread Table**

| FS1<br>(Pin 7) | FS0<br>(Pin 4) | Clock Input<br>Frequency<br>(MHz) | Crystal Input<br>Frequency<br>(MHz) | Spread Amount |
|----------------|----------------|-----------------------------------|-------------------------------------|---------------|
| 0              | 0              | 10-20                             | 10-20                               | ±1.875%       |
| 0              | 1              | 10-20                             | 10-20                               | ±1.0%         |
| 1              | 0              | 20-33                             | 20-25                               | ±1.875%       |
| 1              | 1              | 20-33                             | 20-25                               | -2.0%         |

Note: FS1:0 have internal pull-up resistors

### **Pin Descriptions**

| Pin<br>Number | Pin<br>Name | Pin Type | Pin Description   |
|---------------|-------------|----------|---|
| 1             | X1/CLKIN    | Input    | Crystal or Clock Input.   |
| 2             | X2          | Output   | Crystal output. Float for a clock input.  |
| 3             | GND         | Power    | Connect to ground.  |
| 4             | FS0         | Input    | Select pin for input frequency and spread amount. See table above. Internal pull up resistor. |
| 5             | CLKOUT      | Output   | Spread spectrum clock output per table above.   |
| 6             | VDD         | Power    | Connect to 5V.  |
| 7             | FS1         | Input    | Select pin for input frequency and spread amount. See table above. Internal pull up resistor. |
| 8             | OE#         | Input    | Output Enable. Active Low. See table above. Internal pull-down resistor.                      |



### **External Components**

The ICS4231-03 requires a minimum number of external components for proper operation.

#### **Decoupling Capacitor**

A decoupling capacitor of  $0.01\mu$ F must be connected between VDD and GND on pins 6 and 3, as close to these pins as possible. For optimum device performance, the decoupling capacitor should be mounted on the component side of the PCB. Avoid the use of vias in the decoupling circuit.

#### **Series Termination Resistor**

When the PCB trace between the clock output and the load is over 1 inch, series termination should be used. To series terminate a  $50\Omega$  trace (a commonly used trace impedance) place a  $33\Omega$  resistor in series with the clock line, as close to the clock output pin as possible. The nominal impedance of the clock output is  $20\Omega$ .

value of these capacitors is given by the following equation:

#### **PCB Layout Recommendations**

For optimum device performance and lowest output phase noise, the following guidelines should be observed.

1) The  $0.01\mu$ F decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible. No vias should be used between the decoupling capacitor and VDD pin. The PCB trace to VDD pin should be kept as short as possible, as should the PCB trace to the ground via.

2) To minimize EMI the  $33\Omega$  series termination resistor, if needed, should be placed close to the clock output.

3) An optimum layout is one with all components on the same side of the board, minimizing vias through other signal layers. Other signal traces should be routed away from the ICS4231-03. This includes signal traces just underneath the device, or on layers adjacent to the ground plane layer used by the device.

### **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the ICS4231-03. These ratings, which are standard values for ICS commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| Item                          | Rating            |
|-------------------------------|-------------------|
| Supply Voltage, VDD           | 7V                |
| All Inputs and Outputs        | -0.5V to VDD+0.5V |
| Ambient Operating Temperature | 0 to +70°C        |
| Storage Temperature           | -65 to +150°C     |
| Junction Temperature          | 125°C             |
| Soldering Temperature         | 260°C             |

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# **DC Electrical Characteristics**

| Parameter              | Symbol          | Conditions                                      | Min.   | Тур. | Max.    | Units |
|------------------------|-----------------|---|--------|------|---------|-------|
| Operating Voltage      | VDD             |   | 4.5    | 5    | 5.5     | V     |
| Supply Current         | IDD             | No load, at 3.3V                                |        | 18   | 32      | mA    |
| Input High Voltage     | V <sub>IH</sub> |   | 0.7VDD |      |         | V     |
| Input Low Voltage      | V <sub>IL</sub> |   |        |      | 0.15VDD | V     |
| Output High Voltage    | V <sub>OH</sub> | I <sub>OH</sub> = -24mA                         | 2.5    |      |         | V     |
| Output Low Voltage     | V <sub>OL</sub> | I <sub>OL</sub> = 24mA                          |        |      | 0.4     | V     |
| Input Capacitance      | C <sub>IN</sub> | All pins except X1, X2                          |        | 5    | 7       | pF    |
| Load Capacitance       |                 | X1, X2, as seen by the<br>xtal, Note 1          |        | 17   |         | pF    |
| Output Impedance       | Rout            |   |        | 20   |         | Ω     |
| Input Pull-Up Resistor |                 |   |        | 500  |         | KΩ    |
| Power-Up Time          |                 | First locked clock<br>cycle after Power<br>Good |        |      | 5       | ms    |

Unless stated otherwise, VDD = 5V,  $\pm 10\%$ , Ambient Temperature 0 to  $\pm 70^{\circ}C$ 

Note 1: Pins X1 and X2 each have 34 pF capacitance. When used with a crystal, the total combined capacitance as seen by the crystal is 17 pF. If driving X1 with a clock input, the load capacitance will be 34 pF.

### **AC Electrical Characteristics**

Unless stated otherwise, VDD = 5V $\pm$ 10%, Ambient Temperature 0 to +70° C, C<sub>L</sub>=15pf

| Parameter               | Symbol          | Conditions          | Min. | Тур. | Max. | Units |
|-------------------------|-----------------|---------------------|------|------|------|-------|
| Input Frequency         |                 | Input Clock         | 10   |      | 33   | MHz   |
| Output Frequency        |                 |                     | 10   |      | 33   | MHz   |
| Input Clock Duty Cycle  |                 | Time above VDD/2    | 40   |      | 60   | %     |
| Output Clock Duty Cycle |                 | Note 1              | 45   | 50   | 55   | %     |
| Output Rise Time        | t <sub>OR</sub> | 0.8 to 2.4V, note 1 |      | 2    | 5    | ns    |
| Output Fall Time        | t <sub>OF</sub> | 2.4 to 0.8V, note 1 |      | 2    | 5    | ns    |
| Jitter                  |                 | cycle-to-cycle      |      |      | 300  | ps    |
| Harmonic Reduction      |                 |                     | 8    |      |      | dB    |

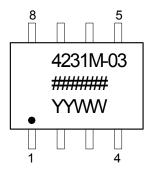
Note 1: Measured with 15pF load



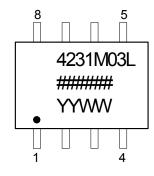
### **Thermal Characteristics**

| Parameter                           | Symbol          | Conditions     | Min. | Тур. | Max. | Units |
|-------------------------------------|-----------------|----------------|------|------|------|-------|
| Thermal Resistance Junction to      | $\theta_{JA}$   | Still air      |      | 150  |      | °C/W  |
| Ambient                             | $\theta_{JA}$   | 1 m/s air flow |      | 140  |      | °C/W  |
|                                     | $\theta_{JA}$   | 3 m/s air flow |      | 120  |      | °C/W  |
| Thermal Resistance Junction to Case | θ <sub>JC</sub> |                |      | 40   |      | °C/W  |

### **Marking Diagram**



# Marking Diagram (Pb free)



#### Notes:

1. ###### is the lot number.

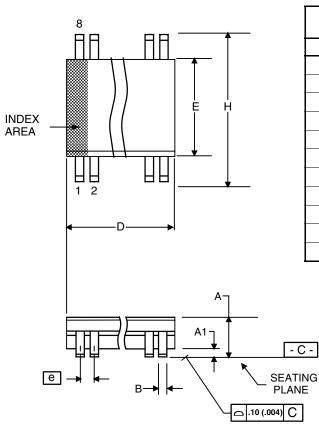
2. YYWW is the last two digits of the year and week that the part was assembled.

- 3. "L" denotes Pb (lead) free package.
- 4. Bottom marking: country of origin.

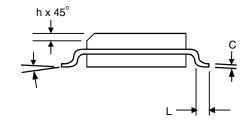


### Package Outline and Package Dimensions (8 pin SOIC, 150 Mil. Body)

Package dimensions are kept current with JEDEC Publication No. 95



|        | Millimeters |            | Inc         | hes        |  |
|--------|-------------|------------|-------------|------------|--|
| Symbol | Min         | Max        | Min         | Max        |  |
| A      | 1.35        | 1.75       | .0532       | .0688      |  |
| A1     | 0.10        | 0.25       | .0040       | .0098      |  |
| В      | 0.33        | 0.51       | .013        | .020       |  |
| С      | 0.19        | 0.25       | .0075       | .0098      |  |
| D      | 4.80        | 5.00       | .1890       | .1968      |  |
| E      | 3.80        | 4.00       | .1497       | .1574      |  |
| е      | 1.27 BASIC  |            | 0.050 BASIC |            |  |
| Н      | 5.80        | 6.20       | .2284       | .2440      |  |
| h      | 0.25        | 0.50       | .010        | .020       |  |
| L      | 0.40        | 1.27       | .016        | .050       |  |
| α      | <b>0</b> °  | <b>8</b> ° | <b>0</b> °  | <b>8</b> ° |  |



### **Ordering Information**

| Part / Order Number | Marking    | Shipping<br>packaging | Package    | Temperature |
|---------------------|------------|-----------------------|------------|-------------|
| ICS4231M-03         |            | Tubes                 | 8-pin SOIC | 0 to +70° C |
| ICS4231M-03T        | see page 5 | Tape and Reel         | 8-pin SOIC | 0 to +70° C |
| ICS4231M-03LF       |            | Tubes                 | 8-pin SOIC | 0 to +70° C |
| ICS4231M-03LFT      |            | Tape and Reel         | 8-pin SOIC | 0 to +70° C |

- C -

"LF" denotes Pb free packaging.

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